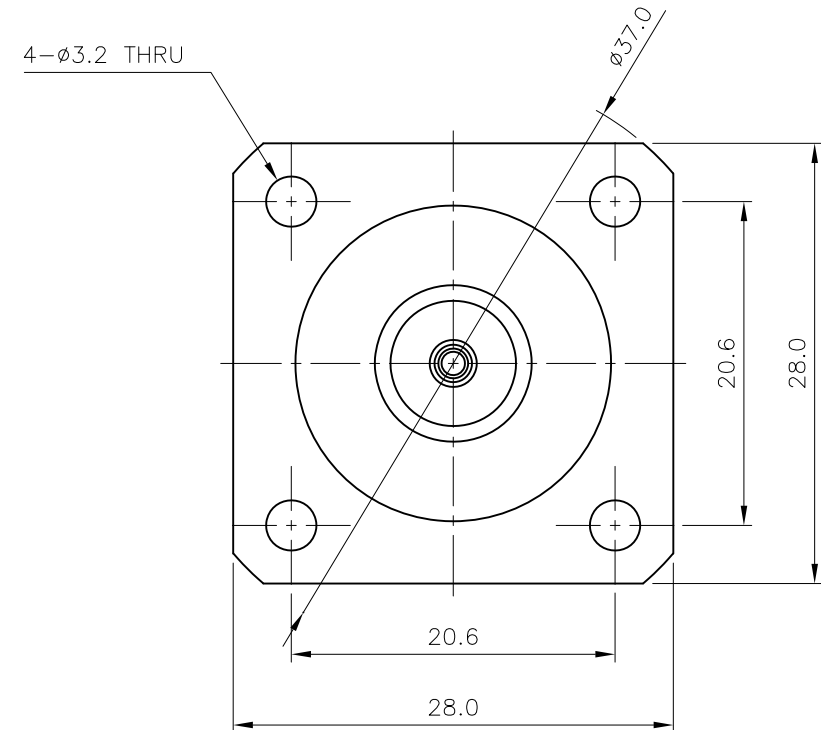
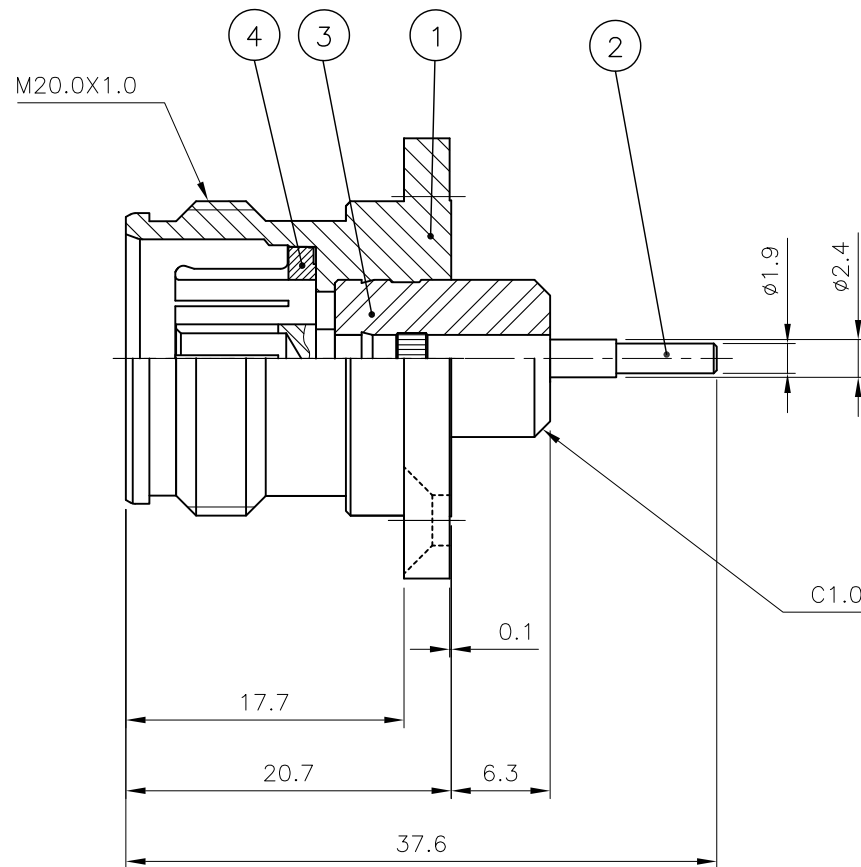
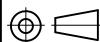


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1	Initial Registration	S.L.SON	J.H.YOUN	2019. 07. 16.
2	Insulator, Pin 길이 변경	K.S.KIM	S.L.SON	2021. 11. 05.



4	JACK	1	MBsBD C3604BD-F	Silver Plate (3μm)	DJA00228-5/6
3	INSULATOR	1	TEFLON		DIN03064-N/2
2	CONTACT	1	BeCu C17300	Silver Plate (5μm)	DCT04033-5/2
1	BODY	1	MBsBD C3604BD-F	SUCO Plate (3μm)	DBD04187-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2021. 11. 05.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY	S.L.SON		
MATERIAL		CHECKED BY	S.L.SON	TITLE 4.3-10 JS-4H Solder End	
		DRAWN BY	K.S.KIM		
FINISH		SCALE	2/1	UNIT	mm
				DWG NO.	CN03856-7/2
		REVISION	2	SHEET	1 of 1